#5247 P.002 /004

FORM PTO-1595 (Modified) (Rev. 03-01)

RECORDATION FORM COVER SHEET

Docket No.: LEE,181

OMB No. 0851-0027 (exp.5/31/2002) P08A/REV03 DATE	NTS ONLY U.S. DEPARTMENT OF COMMER Patent and Trademark Off
TAICI	NTS ONLY Patent and Trademark Off
	-
Name of conveying party(ies): Meng-Jen WANG	Office: Please record the attached original documents or copy thereof. 2. Name and address of receiving party(ies):
	Name: Advanced Semiconductor Engineering, Inc.
	Address: 26 Chin 3rd Rd., Nantze Export Processing Zone,
Additional names(s) of conveying party(ies)	
3. Nature of conveyance:	
☐ Security Agreement ☐ Change of Name	City: Kaohsiung State/Prov.:
□ Other	Country: Taiwan, R.O.C. ZIP:
Execution Date: July 25, 2008	Additional name(s) & address(es) ☐ Yes ☒ No
4. Application number(s) or patent numbers(s):	
If this document is being filed together with a new application), the execution date of the application is:
Patent Application No. Filing date	B. Patent No.(s)
12/183,140 July 31, 2008	-11 210/1(10:10)
Additional numbers	
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Andrew J. Telesz, Jr.	7. Total fee (37 CFR 3.41):\$ 40.00
Registration No. 33,581	Enclosed - Any excess or insufficiency should be credited or debited to deposit account
Address: Volentine & Whitt, P.L.L.C.	
11951 Freedom Drive, Suite 1260	Authorized to be charged to deposit account
	8. Deposit account number:
City: Reston State/Prov.: VA	50-0238
Country: <u>U.S.A.</u> ZIP: <u>20190</u>	(Attach duplicate copy of this page if paying by deposit account)
Statement and signature.	T USE THIS SPACE
To the best of my knowledge and belief, the foregoing inform of the original document.	nation is true and correct and any attached copy is a true copy
Andrew J. Telesz, Jr.	11:10
Name of Person Signing	

Total number of pages including cover sheet, attachments, and document:

VOLENTINE & WHITT, P.L.L.C. (01/2007)

ATTORNEY DOCKET NO. LEF. 181

ASSIGNMENT In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned Insert Name(s) of 1. Mcng-Jen WANG 5. Inventor(s) 2. ______ 6. ____ 3, ______ 7, _____ 4. ______ 8. ____ the undersigned hereby sell(s) and assign(s) to Insert Name(s) of Assignee(s) & ADVANCED SEMICONDUCTOR ENGINEERING, INC. Address(es) Of 26 CHIN 3RD RD., NANTZE EXPORT PROCESSING ZONE, KAOHSTUNG, TAIWAN, R.O.C. (hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as Title of Invention METHOD FOR FORMING VIAS IN A SUBSTRATE Date of for which an application for patent in the United States of America has been executed by Signing of the undersigned on 25 July 2008 Application The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient. The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuing, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference. The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements. The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee. The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

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ATTORNEY DOCKET NO. LEE . [8]

The undersigned hereby grant(s) the practitioners associated with the <u>CUSTOMER NUMBER 20987</u> the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned Date 25 July 2008 Signature of Inventor Meng-Jen Wang Date _____ Signature of Inventor __ Date _____ Signature of Inventor ____ Date _____ Signature of Inventor _____ Date _____ Signature of Inventor _____ Date _____ Signature of Inventor Date ______ Signature of Inventor _____ Date _____ Signature of Inventor _____ (Note regarding Witnessing: It is recommended that the execution by the Inventor(s) be witnessed by at least two witnesses who sign here. However, the current practice of the U.S. Patent and Trademark Office is to record an Assignment even it has not been witnessed.) Witness.... Applicant Reference No. A01727/US0586-LPJ

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PATENT REEL: 021346 FRAME: 0510